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(to be used for all correspondence after initial filing)

Total Number of Pages in This Submission

Application Number 10/689,958

Filing Date October 20, 2003

First Named Inventor Cem Basceri

Art Unit 2812

Examiner Name Unknown

Attorney Docket Number MI22-2417

ENCLOSURES (Check all that apply)

<input type="checkbox"/> Fee Transmittal Form	<input type="checkbox"/> Drawing(s)	<input type="checkbox"/> After Allowance Communication to TC
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Printed name	Mark S. Matkin		
Date	10/28/04	Reg. No.	32,268

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EV372470007



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application Serial No..... 10/689,958
Filing DateOctober 20, 2003
Inventor Cem Basceri
Assignee Micron Technology, Inc.
Group Art Unit 2812
Examiner Unknown
Attorney Docket No.....MI22-2417
Customer No.021567
Title: Methods of Forming Conductive Metal Silicides by Reaction of Metal with
Silicon

INFORMATION DISCLOSURE STATEMENT

References -- See Attached Form PTO-1449


The attached form PTO-1449 is submitted in compliance with 37 CFR §1.56. Pursuant to 1276 OG 55, August 5, 2003, no copies of cited U.S. patents or U.S. patent application publications are included, as the date of filing of this patent application occurs after June 30, 2003. Copies of all other references are attached. No admission is made regarding whether all the listed references are prior art.

Citation of the referenced art is respectfully requested.

This Information Disclosure Statement is being filed before the mailing date of a first Office Action. There, no fee is believed to be required. However, in the event that a fee is required for filing this Information Disclosure Statement, please charge the fee specified under 37 C.F.R. § 1.17(p) to Deposit Account No. 23-0925.

Respectfully submitted,

Dated: 10-25-04

By: 
Mark S. Matkin
Reg. No. 32,268

Form PTO-1449		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE			ATTY. DOCKET NO. MI22-2417		SERIAL NO. 10/689,958	
LIST OF ART CITED BY APPLICANT (Use several sheets if necessary)					APPLICANT: Cem Basceri			
					FILING DATE October 20, 2003		GROUP 2812	

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U.S. PATENT DOCUMENTS							
*Examiner's Initials	Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate	
AA	3,349,474	12/1963	D. H. Rauscher				
AB	5,904,517	05/1999	Gardner et al.	438	197		
AC	5,998,264	12/1999	Wu	438	260		
AD	6,180,465 B1	01/2001	Gardner et al.	438	291		
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AH	2003/0045060 A1	03/2003	Ahn et al.	438	287		
AI	2003/0045078 A1	03/2003	Ahn et al.	438	585		

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Document Number	Date	Country	Class	Subclass	Translation		
					Yes	No	
AJ	EP 0 851 473 A2	01/1998	EPO		X		
AK							
AL							

OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)		
AM		Chang et al., Silicon surface treatments in advanced MOS gate processing, Microelectronic Engineering, (2004), pages 130-135
AN		Lemberger et al., Electrical characterization and reliability aspects of zirconium silicate films obtained from novel MOCVD precursors, Microelectronic Engineering (2004), pages 315-320
AO		Lu et al., Effects of the TaN _x interface layer on doped tantalum oxide high-k films, VACUUM (2004), pages 1-9
EXAMINER		DATE CONSIDERED

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FOREIGN PATENT DOCUMENTS								
		Document Number	Date	Country	Class	Subclass	Translation	
							Yes	No
	AJ							
	AK							
	AL							

OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)			
AM		Robertson et al., Atomic structure, band offsets, growth and defects at high-K oxide:Si interfaces, Microelectronic Engineering (2004) pages 112-120	
AN		Singh et al., High and Low Dielectric Constant Materials, The Electrochemical Society <i>Interface</i> , Summer 1999, pages 26-30	
AO			
EXAMINER		DATE CONSIDERED	

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